

Prototyping the Nb coating of the copper Wide Open Waveguide Crab Cavity for FCC-hh

Fabian Manke, Fabio Avino, Alexej Grudiev, Ana Teresa Perez Fontenla, Thibaut Richard, Alban Sublet, Mauro Taborelli

01/07/2021

FCC week 2021

Outline

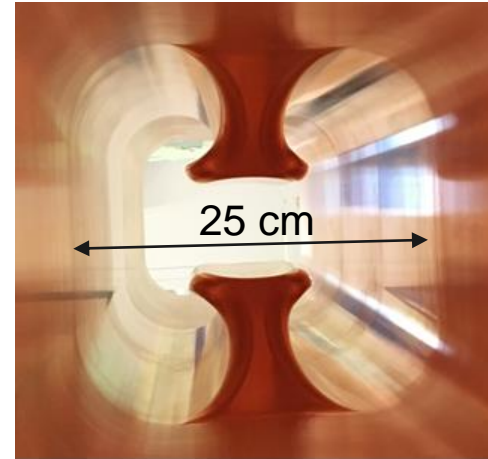
- 1. The WOWCC and its coating process**
- 2. The coating recipe: HiPIMS with Positive Pulse**
- 3. Coatings on a small-scale mock-up**
- 4. Prototyping at full-scale**

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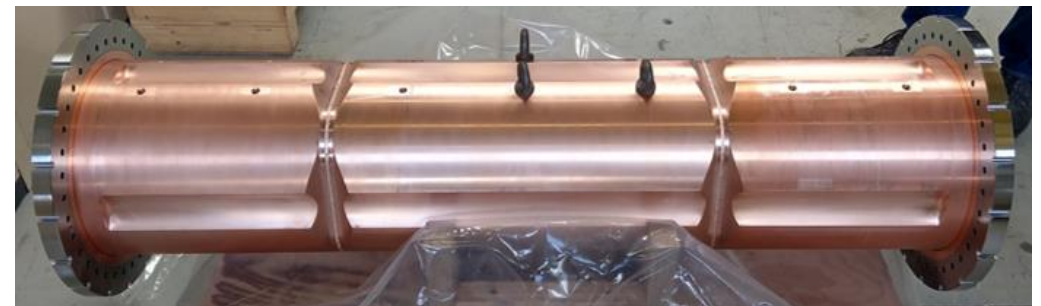
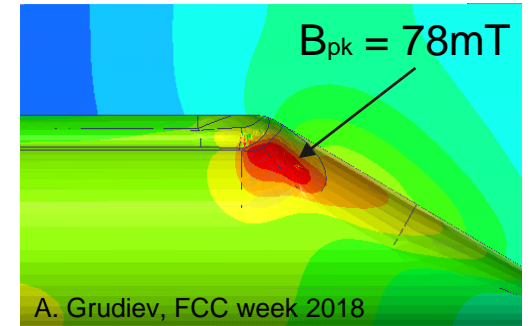
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1 The Wide-Open Waveguide Crab Cavity

- **bunch tilting for head-on collisions**
- **key design features:**
 - low shunt impedances
 - outside HOM damping
 - optimized deflecting field quality
 - Nb/Cu: stable operation at 4.5 K
 - **design compatible with coating**



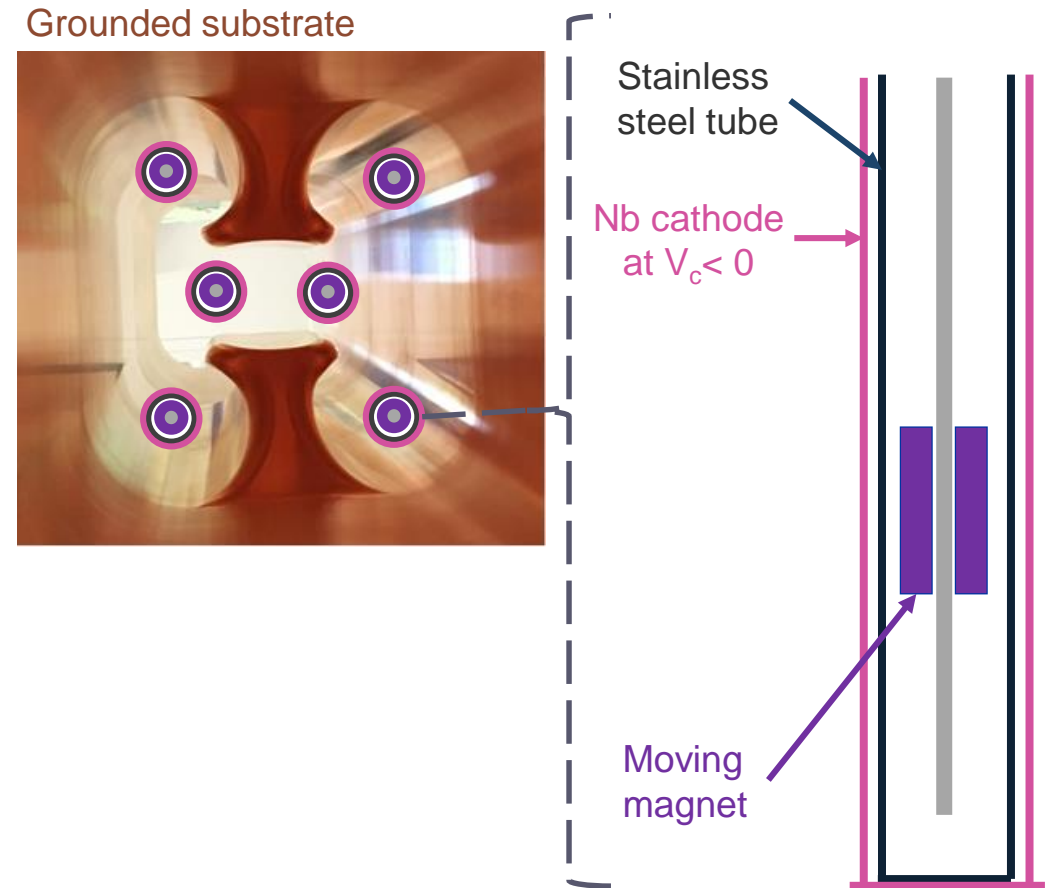
$$Q_0 = 4 \times 10^8$$
$$P_{\text{loss}} = 67 \text{ W at } 3\text{MV}$$



K. Papke et al, Phys. Rev. Accel. Beams 22, 072001, 2019

1 Multi-cathode coating set-up

- **Assembly of six independent cylindrical cathodes**

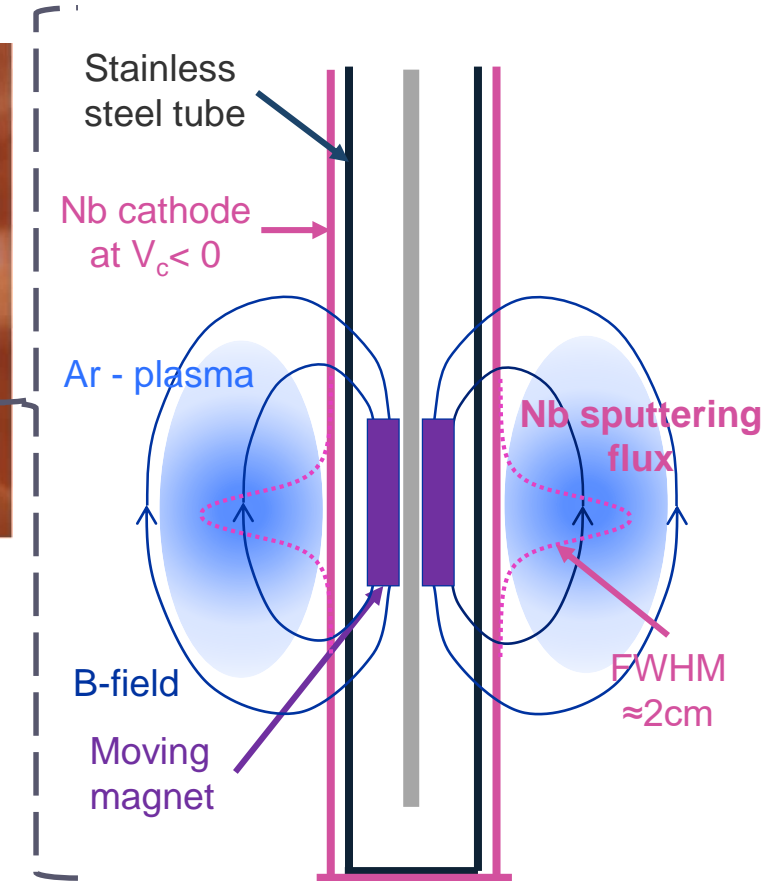
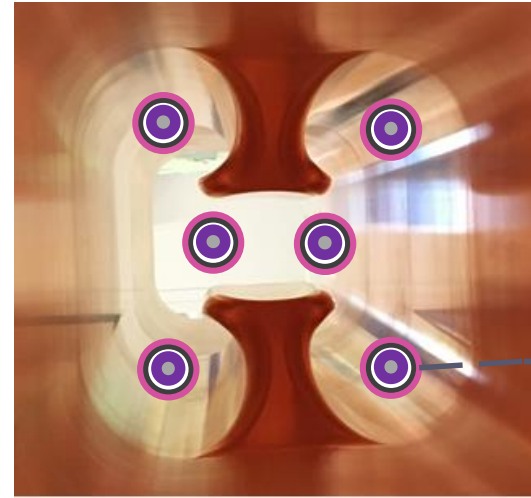


F. Avino et al, TTC, 5th February 2020, Geneva

1 Multi-cathode coating set-up

- Assembly of six independent cylindrical cathodes
- Magnetron sputtering

Grounded substrate

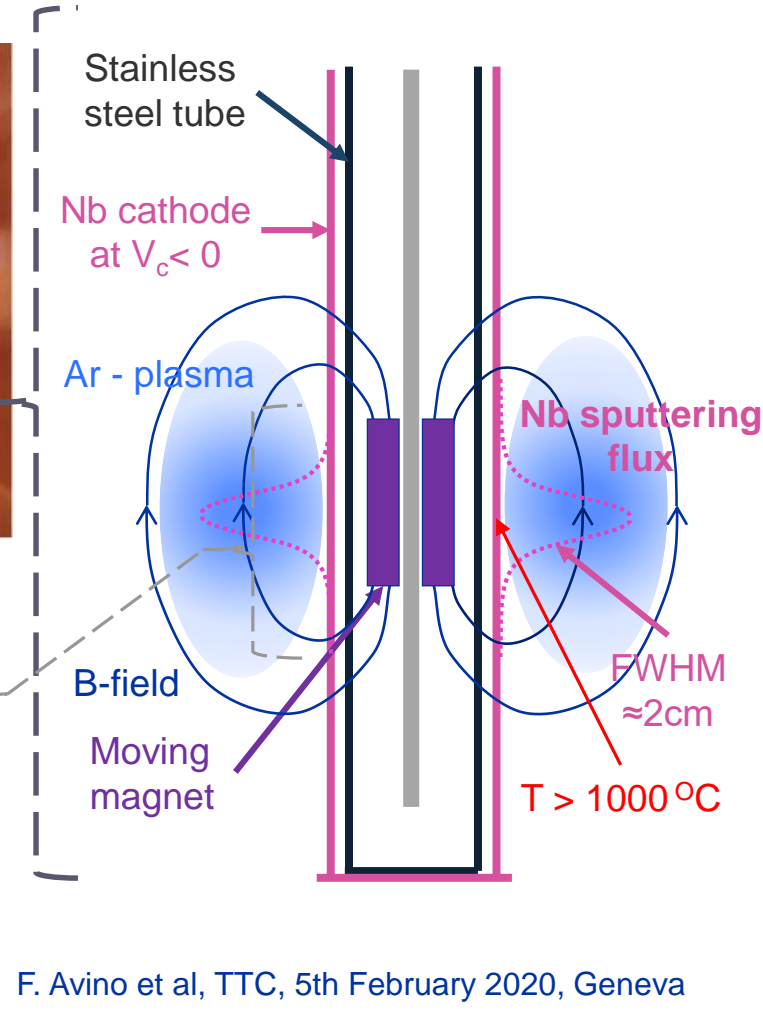
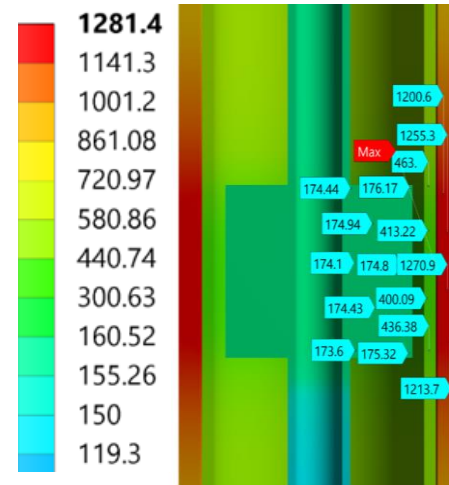
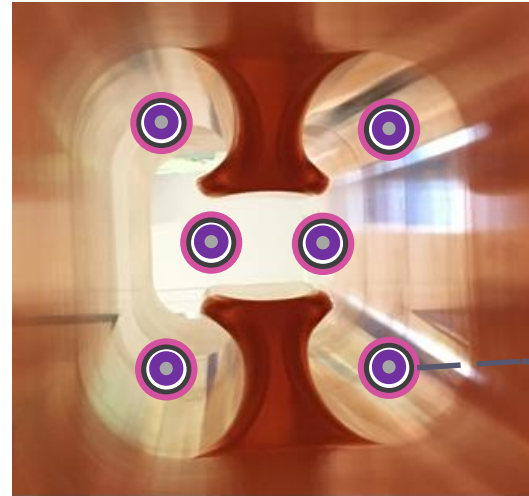


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1 Multi-cathode coating set-up

- Assembly of six independent cylindrical cathodes
- Magnetron sputtering
- Cathode heats quickly

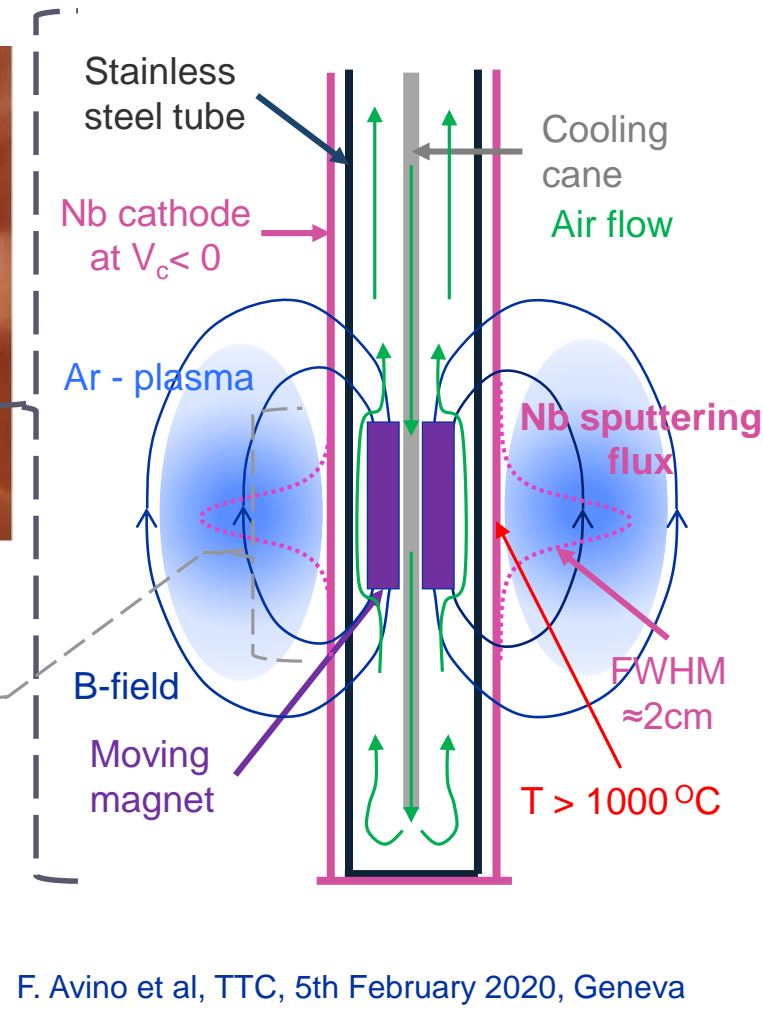
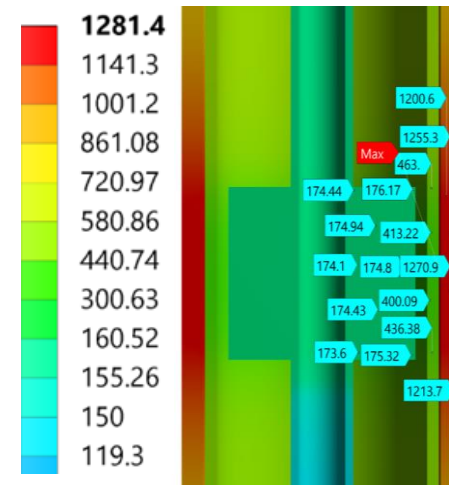
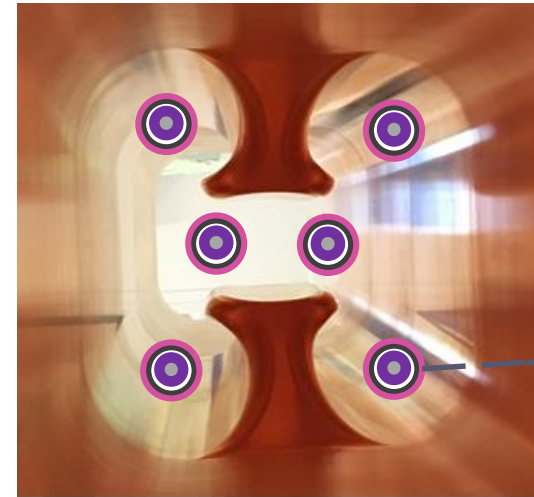
Grounded substrate



1 Multi-cathode coating set-up

- Assembly of six independent cylindrical cathodes
- Magnetron sputtering
- Cathode heats quickly
- Require magnet cooling

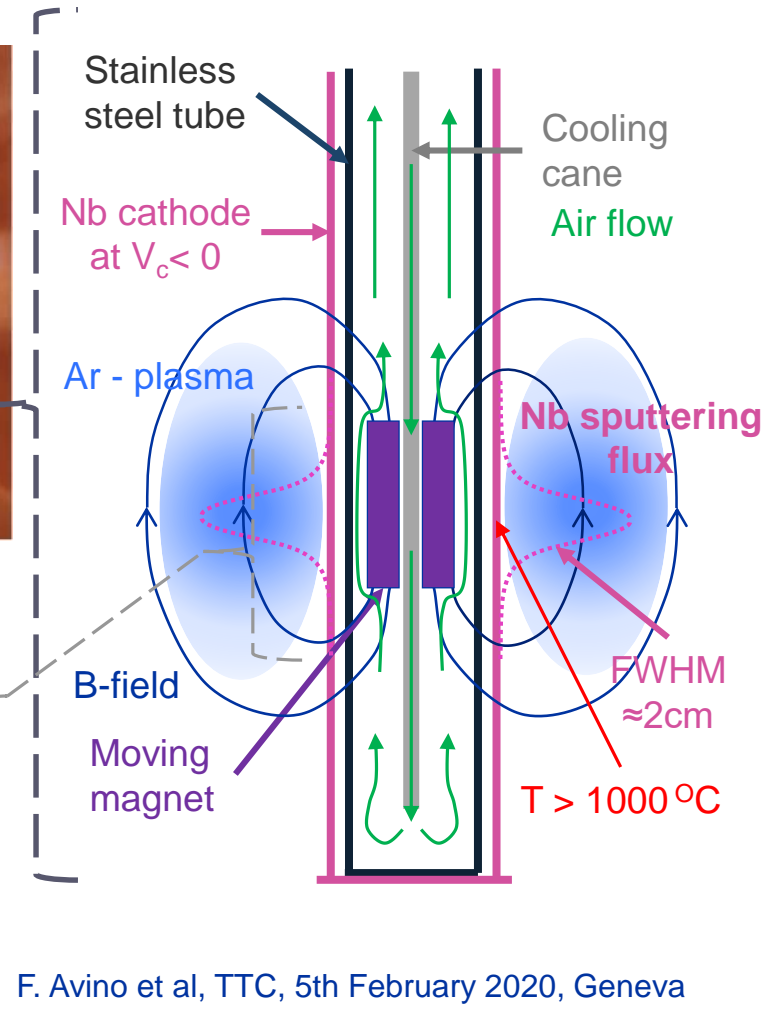
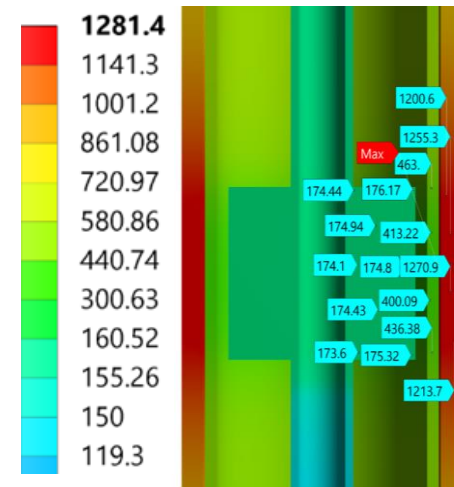
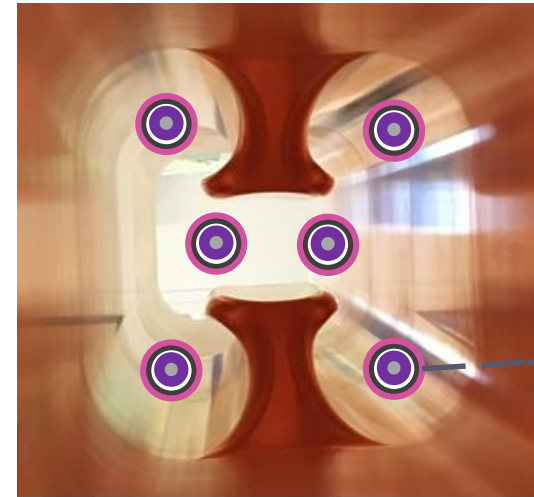
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1 Multi-cathode coating set-up

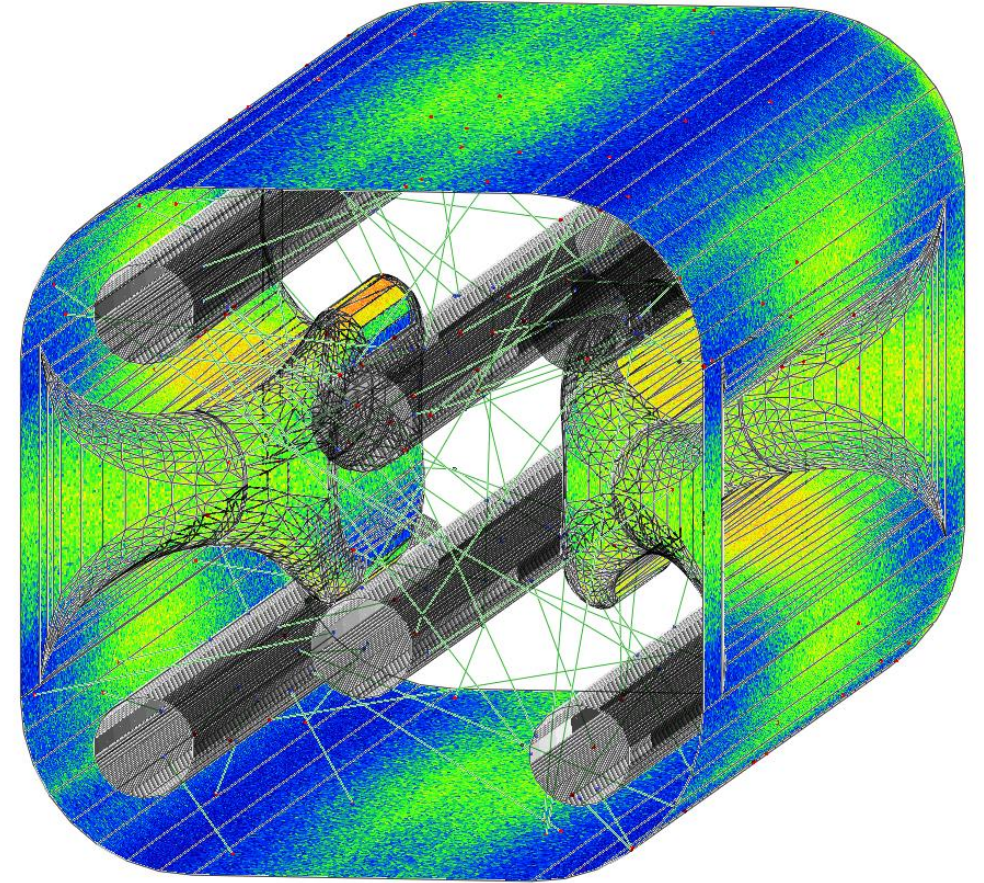
- Assembly of six independent cylindrical cathodes
 - Magnetron sputtering
 - Cathode heats quickly
 - Require magnet cooling
-
- Coating uniformity factor $\times 2$

Grounded substrate



1 Process planning with *Molflow*¹

- in-house ray-tracing based MC code
 - simulates ideal gas in closed system
- ONLY Nb atoms from input-profiles



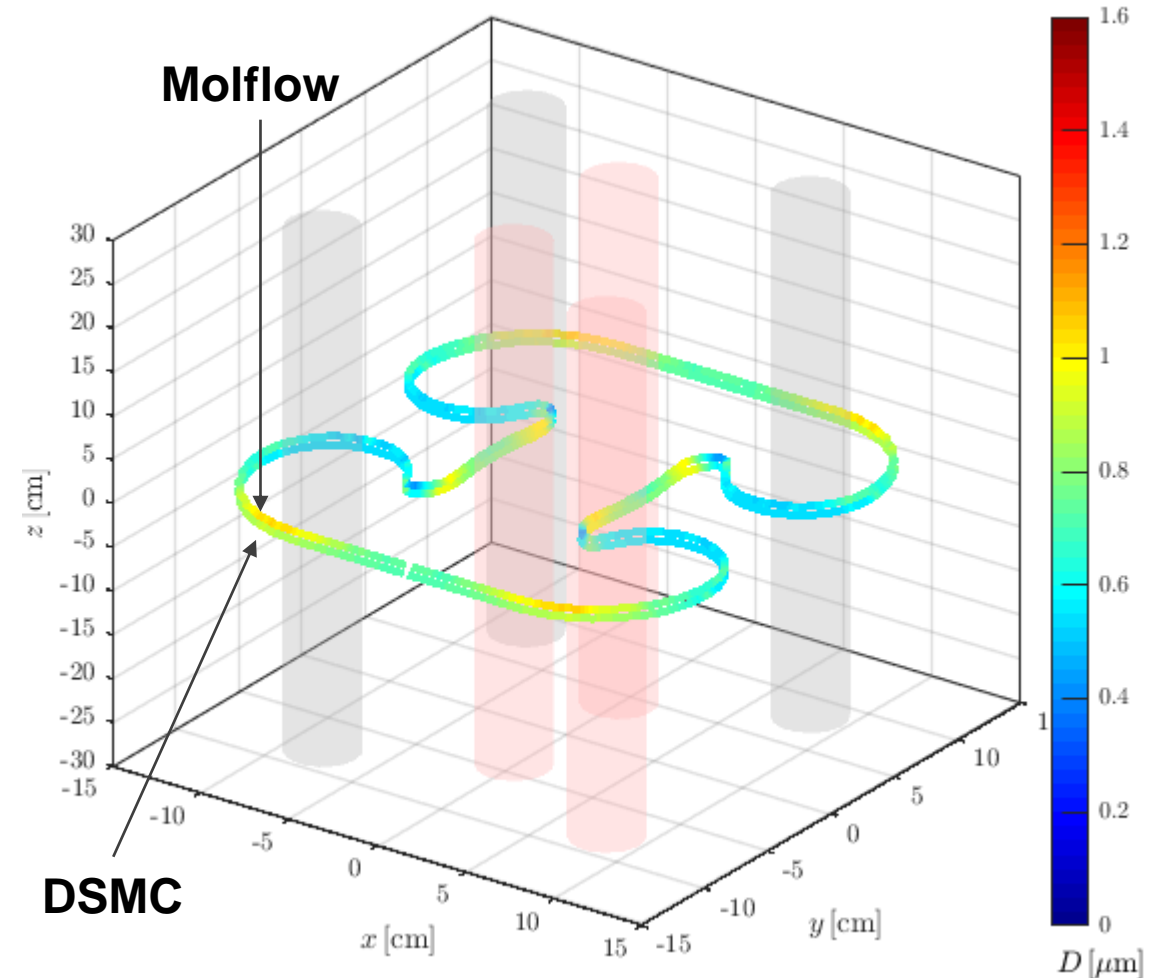
[1] M. Ady, R. Kersevan, 10th Int. Particle Accelerator Conf., Melbourne, 2019, doi:10.18429/JACoW-IPAC2019-TUPMP037

1 Process planning with *Molflow*

- in- house ray-tracing based MC code
- simulates ideal gas in closed system
- ONLY Nb atoms from input-profiles
- Find at worst local $\approx 25\%$ deviation from fully collisional DSMC code^[2,3]

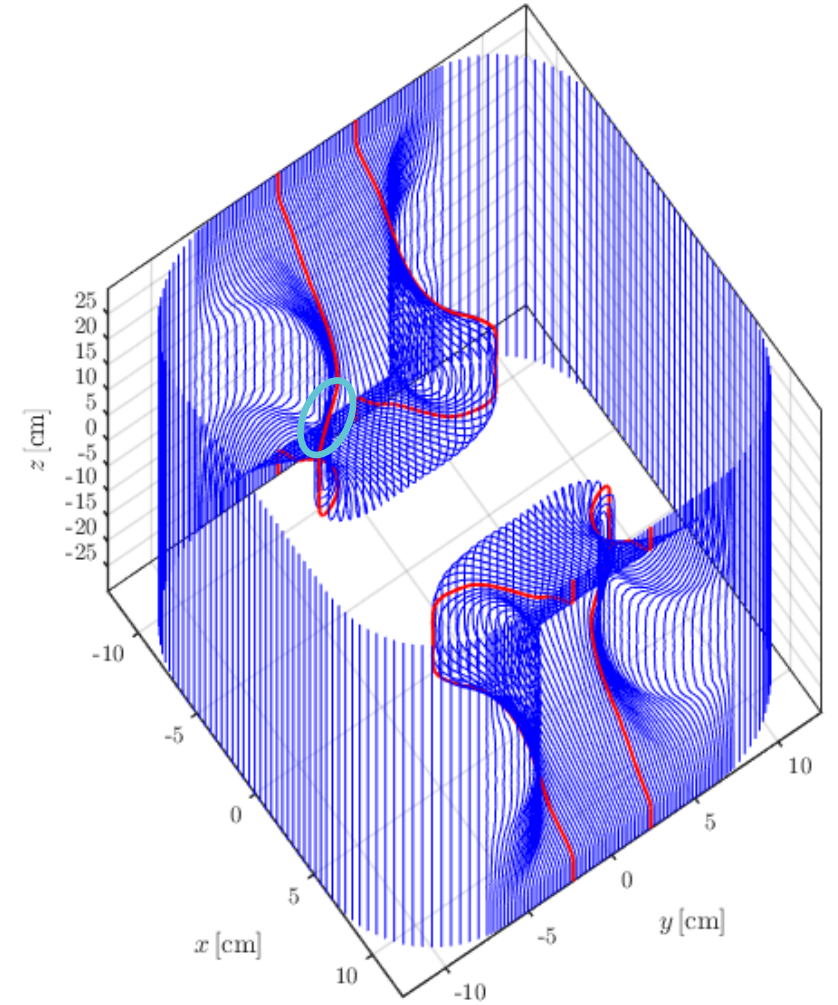
[2] A. Pflug, DSMC/PIC-MC Code Documentation, Fraunhofer IST, Braunschweig, Germany, <https://simulation.ist.fraunhofer.de/doku.php?id=start>

[3] F. Avino et al, TTC, 5th February 2020 Geneva



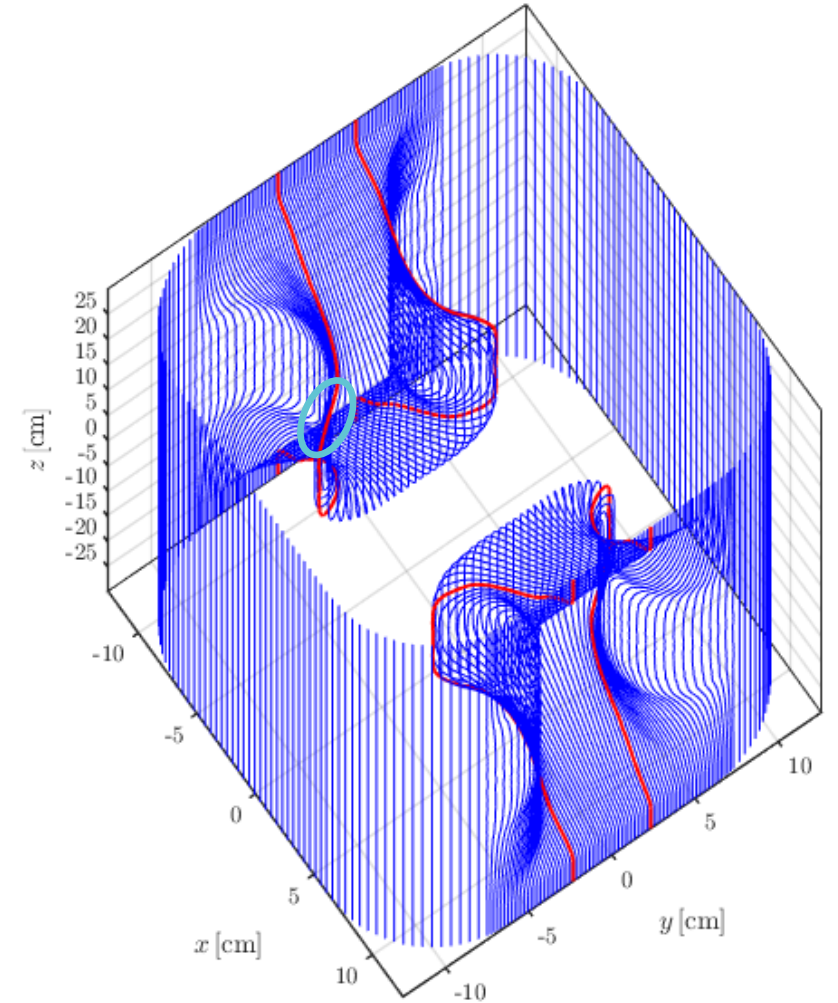
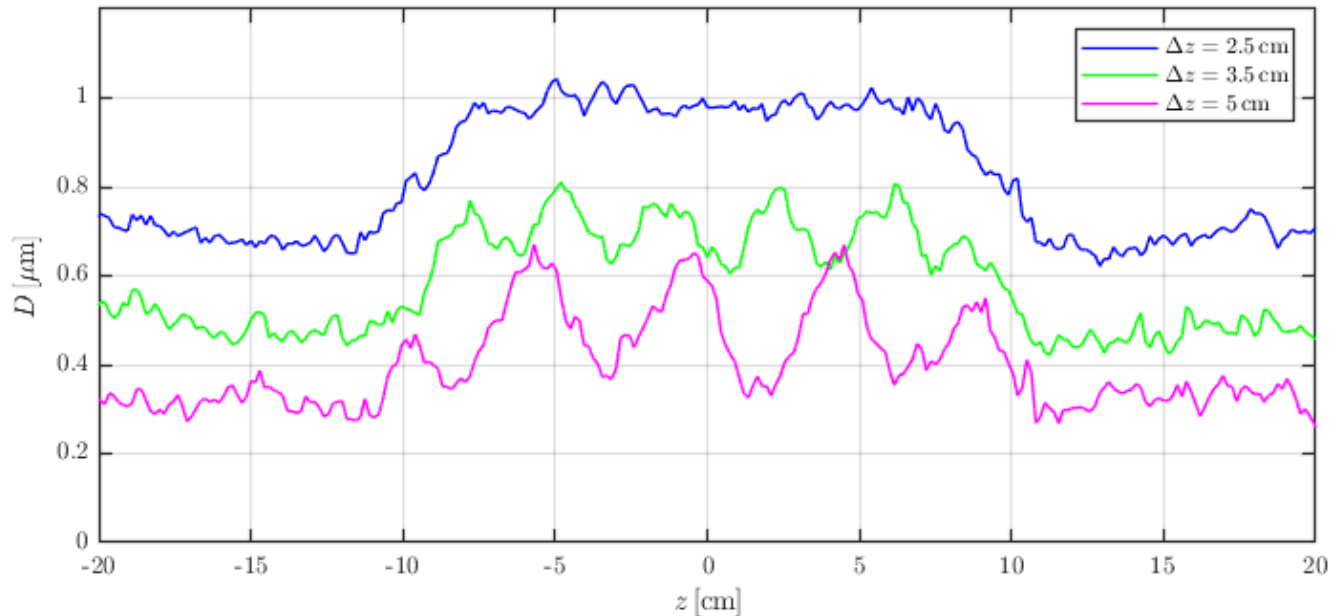
1 Process planning with *Molflow*

- Axial profiles along relevant regions (e.g. RF hotspot)



1 Process planning with *Molflow*

- Axial profiles along relevant regions (e.g. RF hotspot)
- Identify **2.5 cm** as minimum process step-size, especially in critical areas

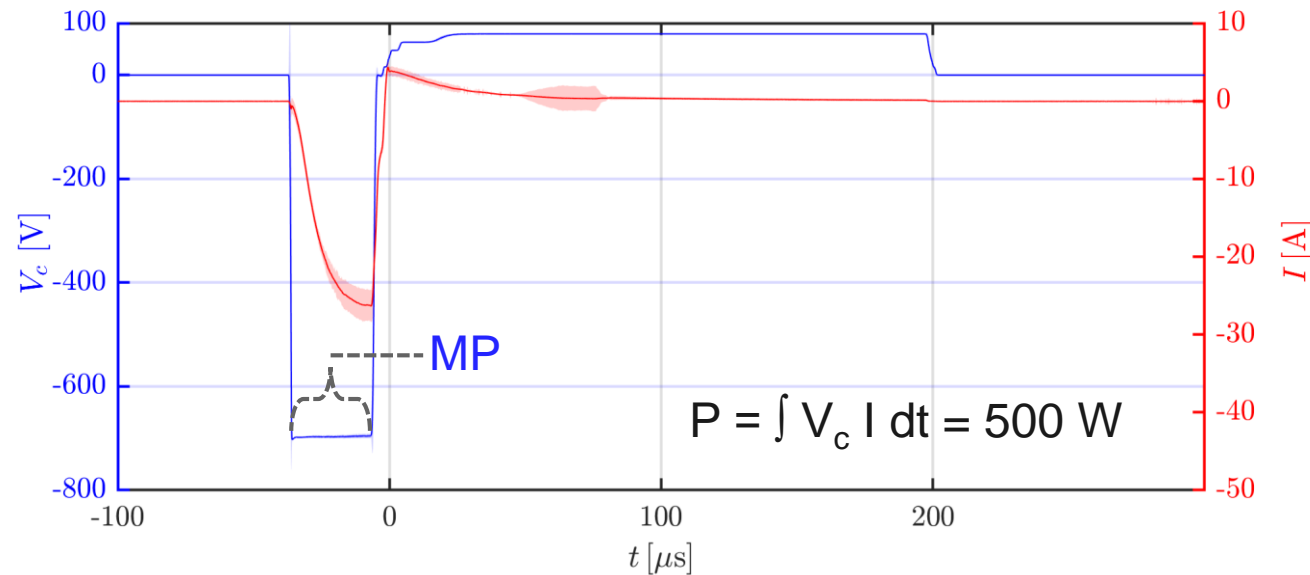


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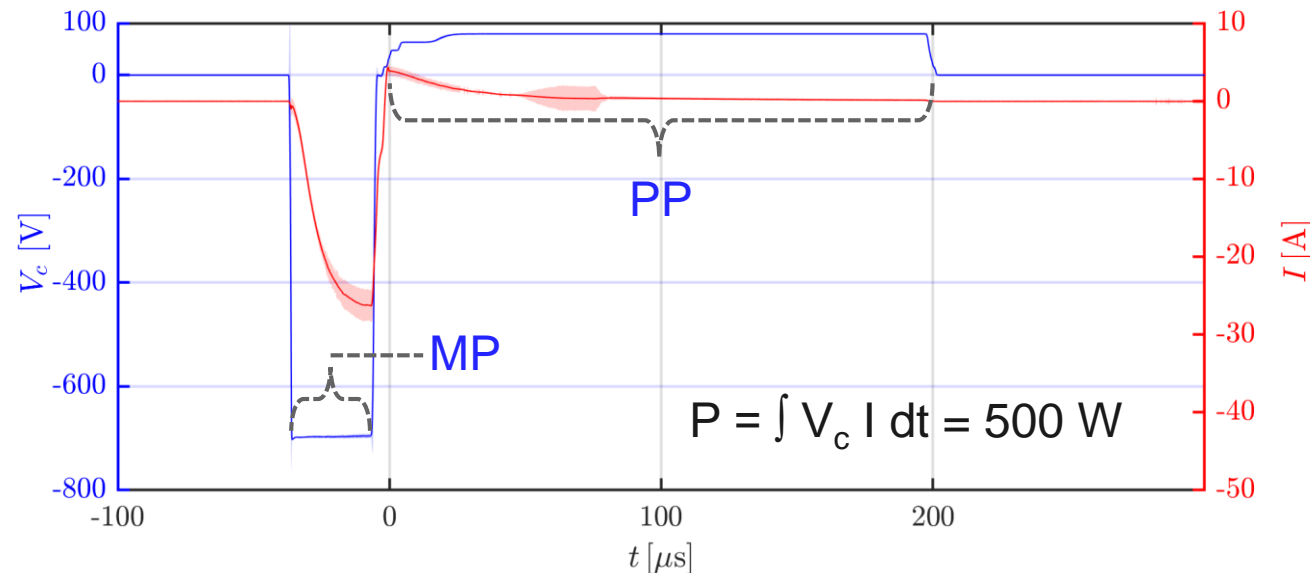
2 HiPIMS coating recipe

- **High Power Impulse Magnetron Sputtering**
 - V_c during Main Pulses (MP), at 1kHz with <10% duty cycle
 - same time-average power fix-points as DC Magnetron Sputtering



2 HiPIMS coating recipe

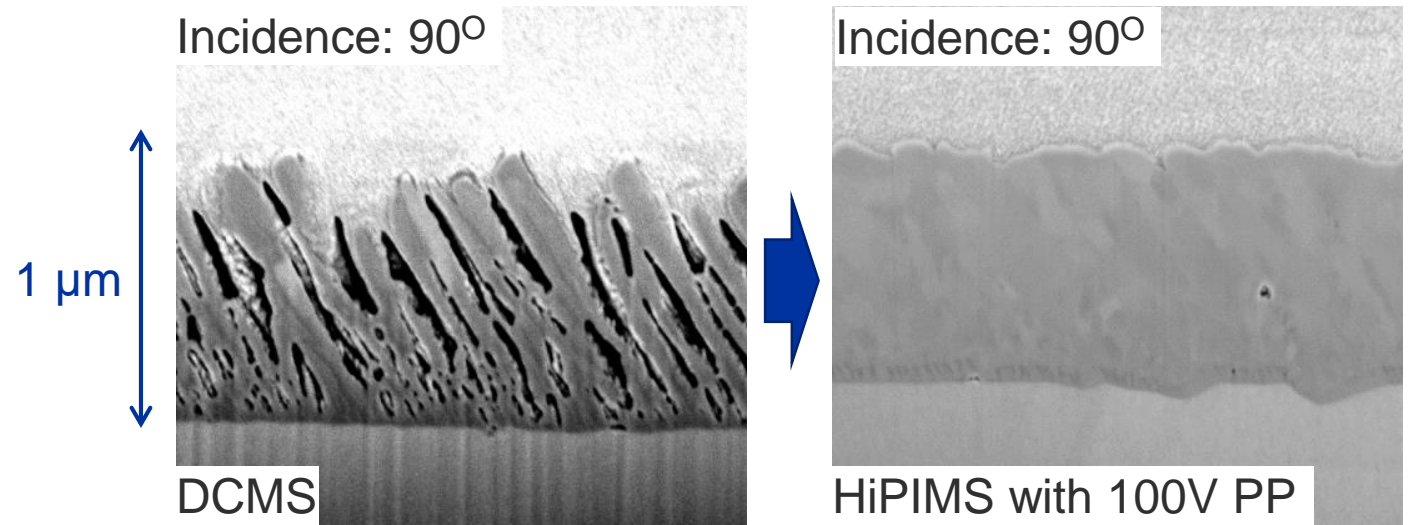
- **High Power Impulse Magnetron Sputtering**
 - V_c during Main Pulses (MP), at 1kHz with <10% duty cycle
 - Same time-average power fix-points as DC Magnetron Sputtering
 - Denser plasmas (x10) with higher fraction of Nb^+
 - Accelerate Nb^+ by Positive Pulses (PP) for denser, less columnar films



2 Thin film densification

- **High Power Impulse Magnetron Sputtering**
 - V_c during Main Pulses (MP), at 1kHz with <10% duty cycle
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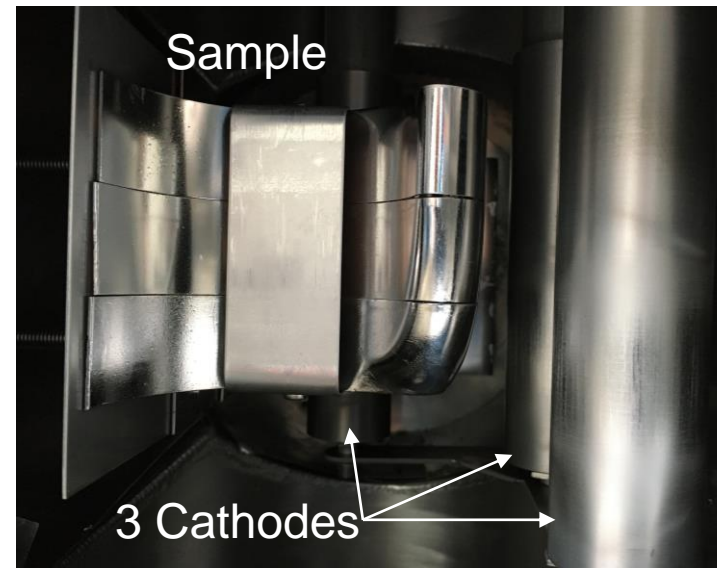
→ Very promising on planar samples, especially at *grazing* incidence



[3] F. Avino et al, Thin Solid Films 706, 138058, 2020

2 Moving to the WOWCC geometry

- **High Power Impulse Magnetron Sputtering**
 - V_c during Main Pulses (MP), at 1kHz with <10% duty cycle
 - Same time-average power fix-points as DC Magnetron Sputtering
 - Denser plasmas (x10) with higher fraction of Nb⁺
 - Accelerate Nb⁺ by Positive Pulses (PP) for denser, less columnar films
- Very promising on planar samples, especially at grazing incidence
- Tests in 3-cathode mock-up system
- Samples mimic hot-spot region 1:1

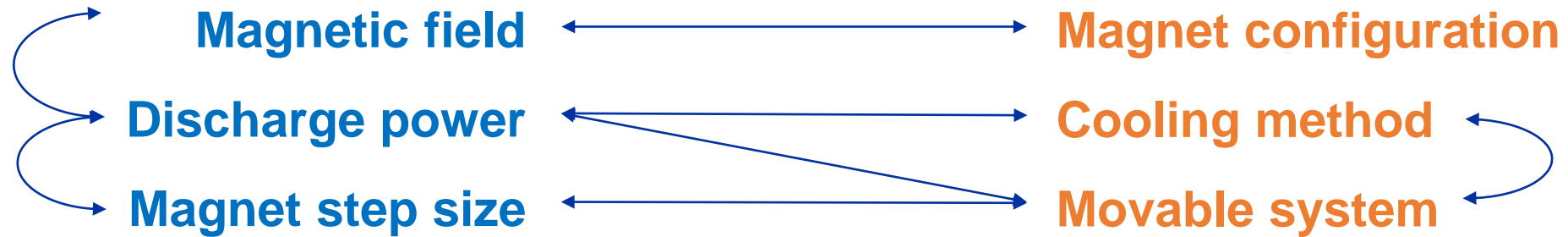


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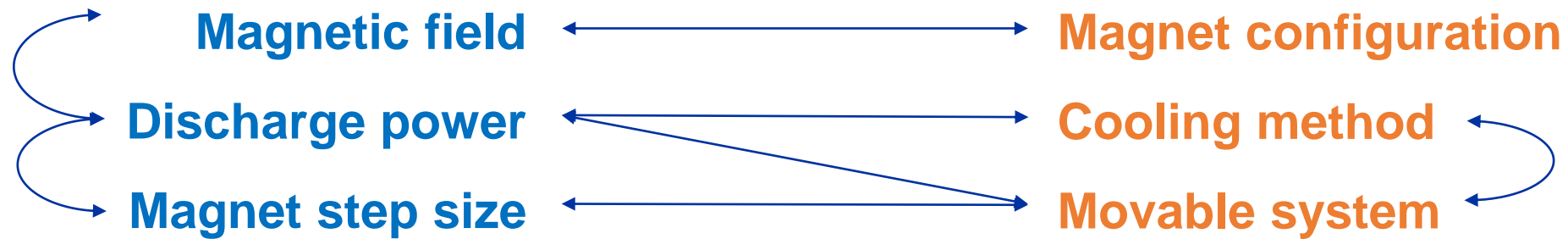
2 Three-cathode coatings on mock-up samples

- Qualify coating thickness and morphology in critical areas (RF hotspot)
- Define *process parameters* and *prototype equipment*



2 Three-cathode coatings on mock-up samples

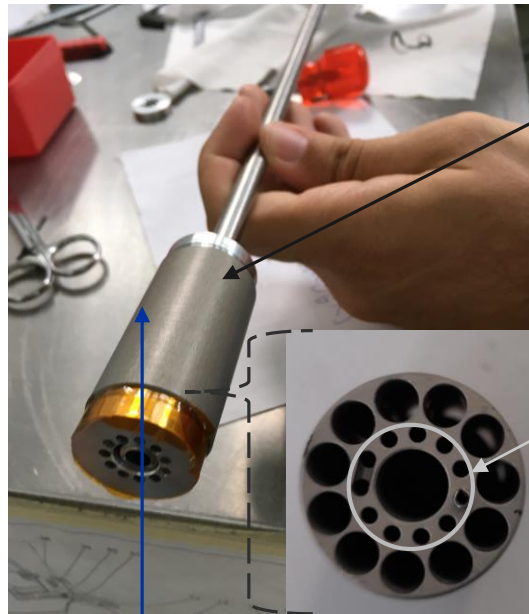
- Qualify coating thickness and morphology in critical areas (RF hotspot)
- Define *process parameters* and *prototype equipment*



- **Practical constraints:**
 - Heat loads on magnet and substrate
 - Mechanical precision and reliability
 - Handling on full-scale

2 Composite “revolver” vs. bulk magnet

→ Better cooling vs. stronger field (better confinement)



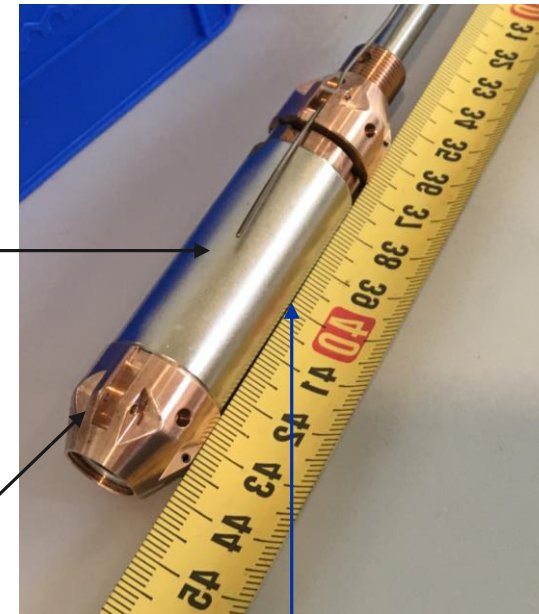
$B_{\text{mid}} \approx 35 \text{ mT}$

Smaller magnets
in “revolver” housing

Bulk magnet

Cooling channels

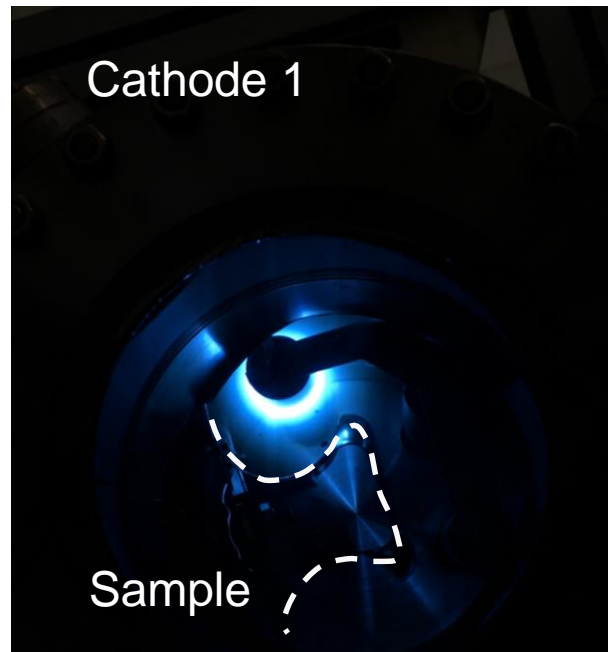
Tapered ends for
surface cooling



$B_{\text{mid}} \approx 85 \text{ mT}$

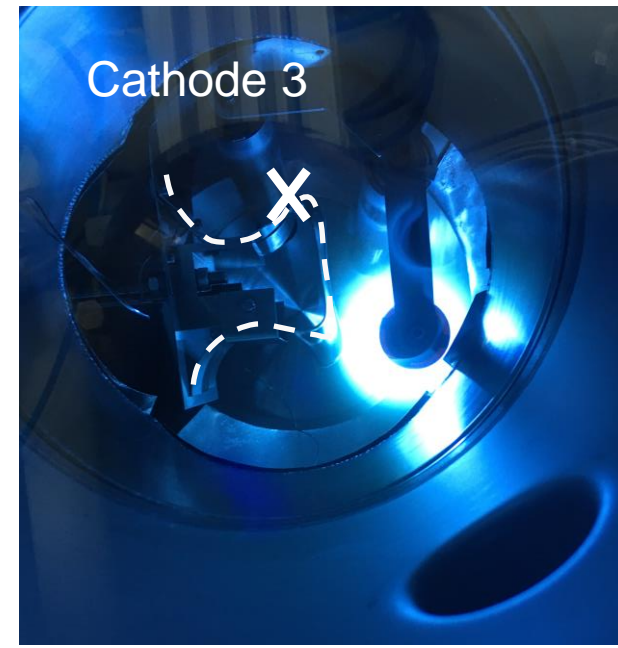
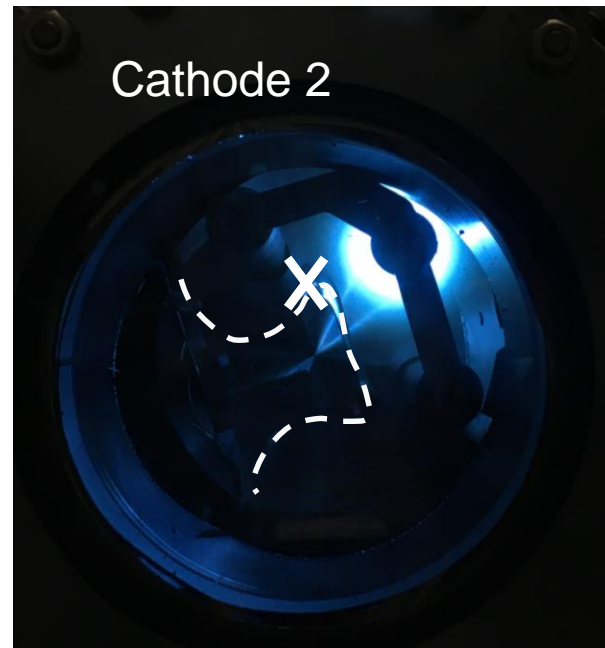
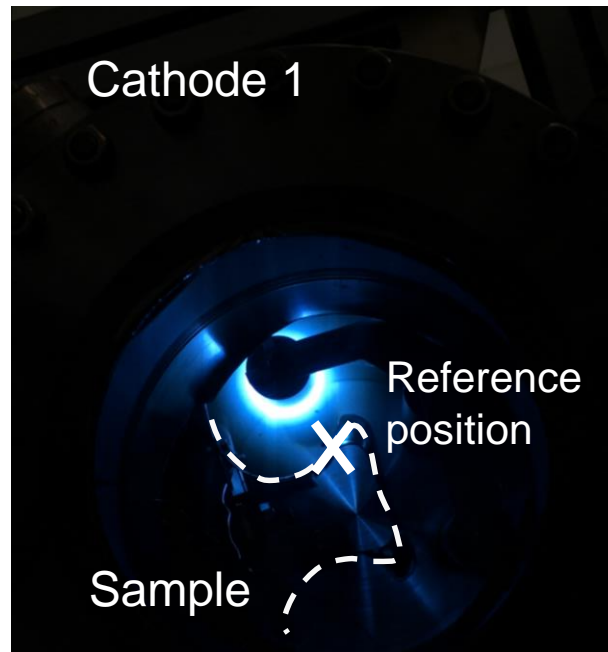
2 Composite “revolver” vs. bulk magnet

- Better cooling vs. stronger field (better confinement)
- Baseline tests at $P=500W$ for 40 mins, cathodes in sequence:



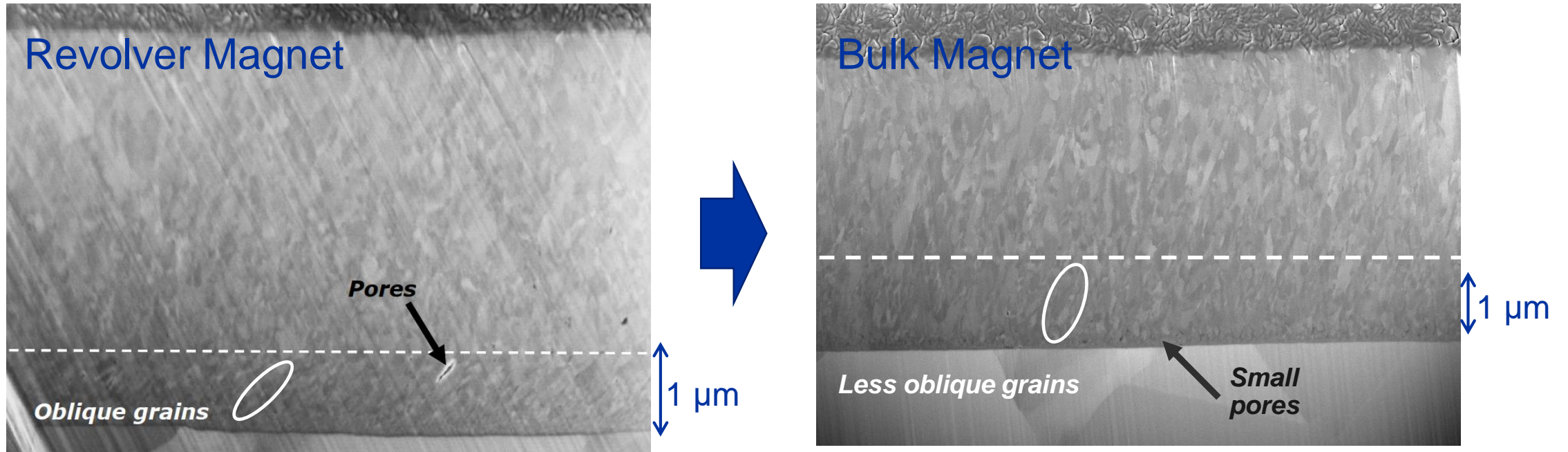
2 Composite “revolver” vs. bulk magnet

- Better cooling vs. stronger field (better confinement)
- Baseline tests at $P=500W$ for 3×40 mins, cathodes in sequence:



2 Improved coating morphology

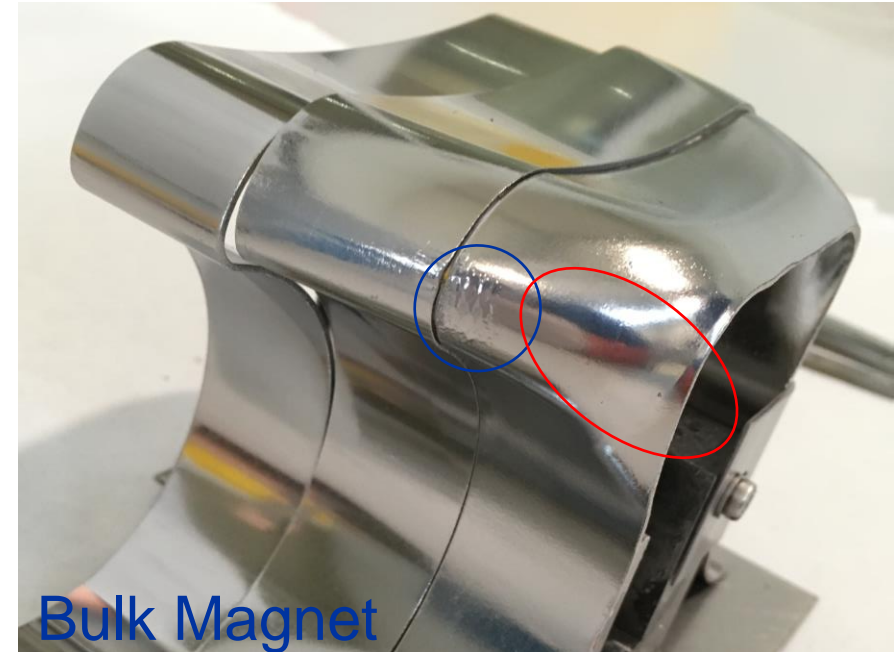
→ bulk magnet provides more Nb⁺ ions reacting to Positive Pulse



→ Less oblique grains, small pores only near Nb/Cu interface

2 Improved coating adhesion

→ single magnet provides more Nb⁺ ions reacting to Positive Pulse



→ Better overall adhesion and less delamination near **RF hot-spot**

2 Coatings at higher power

- **1kW coating with bulk magnet for 20 mins coating duration**
- **faster coating vs. higher heat load**

2 Coatings at higher power

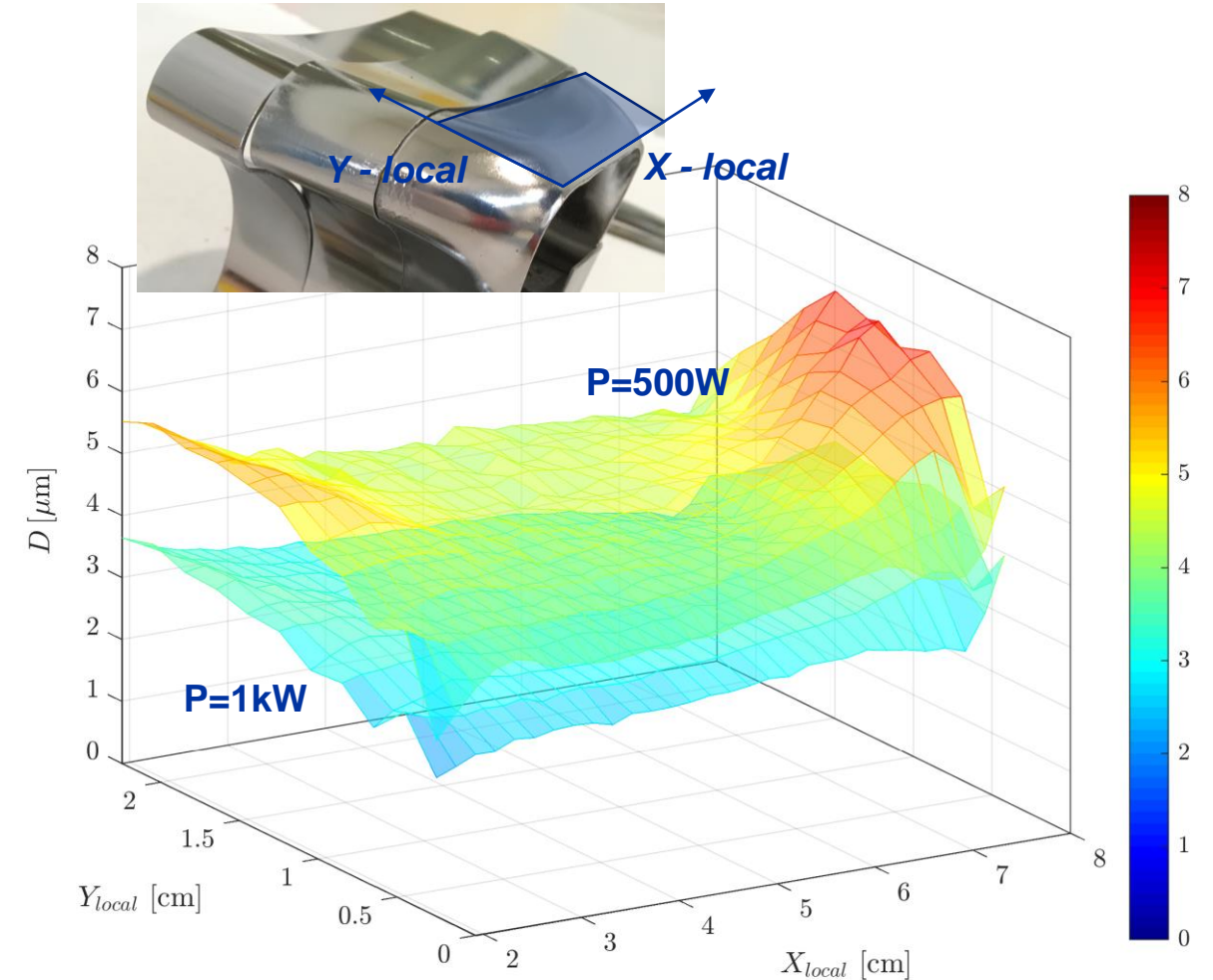
- 1kW coating with bulk magnet for 20 mins coating duration

→ faster coating vs. higher heat load

- Expect from basic scaling:

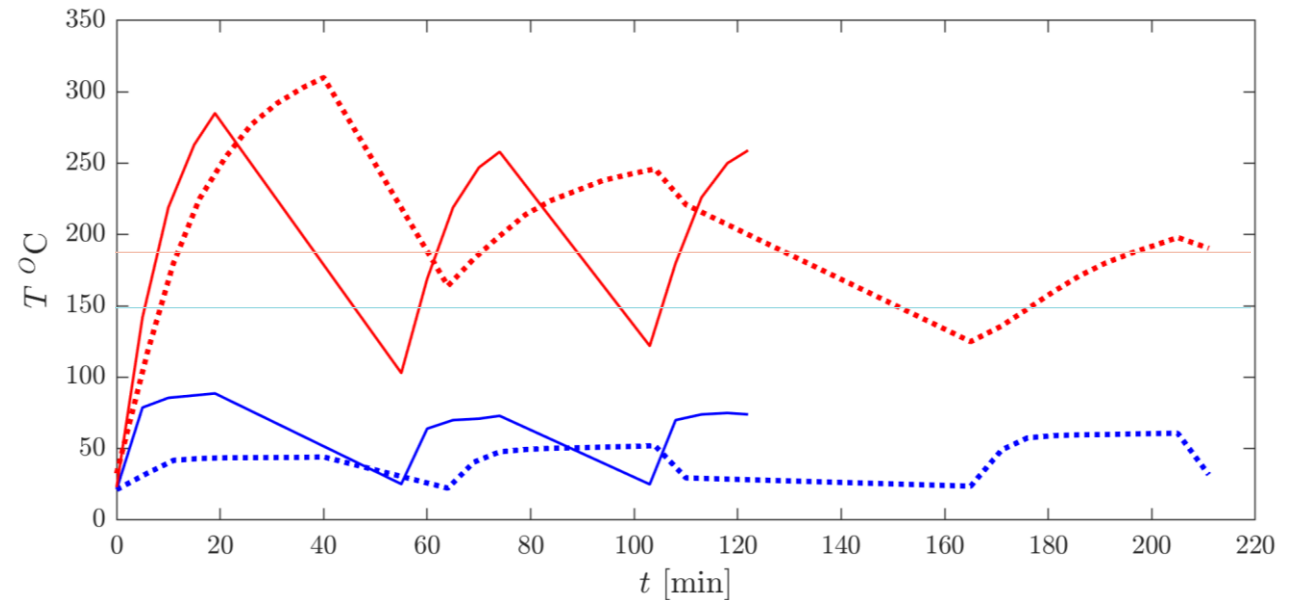
$$\frac{D(1kW)}{D(500W)} \approx \frac{(P \times t)|_{1kW}}{(P \times t)|_{500W}} \approx 1$$

- XRF thickness profile suggests coating rate is $\approx 20\text{-}30\%$ lower



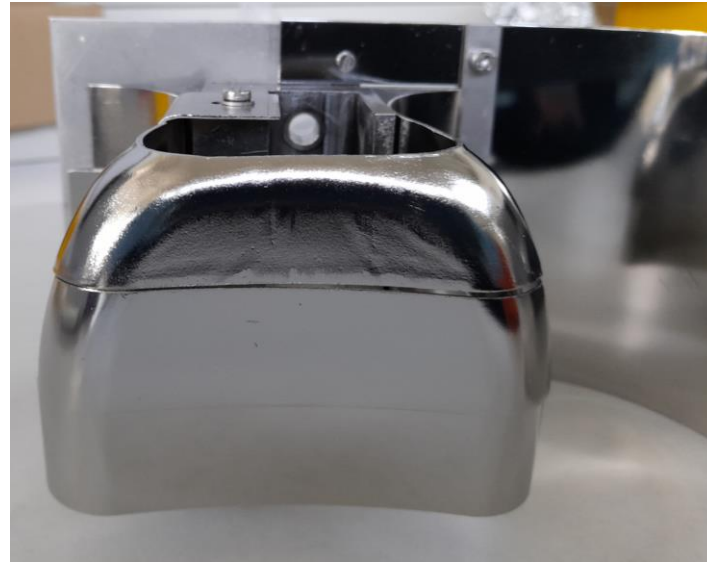
2 Sequential coating heat loads

- Compare **magnet** and **sample** temperatures at 500W (dashed) and 1kW
- Magnet below critical 150°C
- Air cooling sufficient
- Thin sample as *worst-case* scenario of bulk Cu cavity
- $\Delta T \propto P \times t \approx cst$
- Exceed 180°C of bake-out within few minutes !



2 Sequential coating heat loads

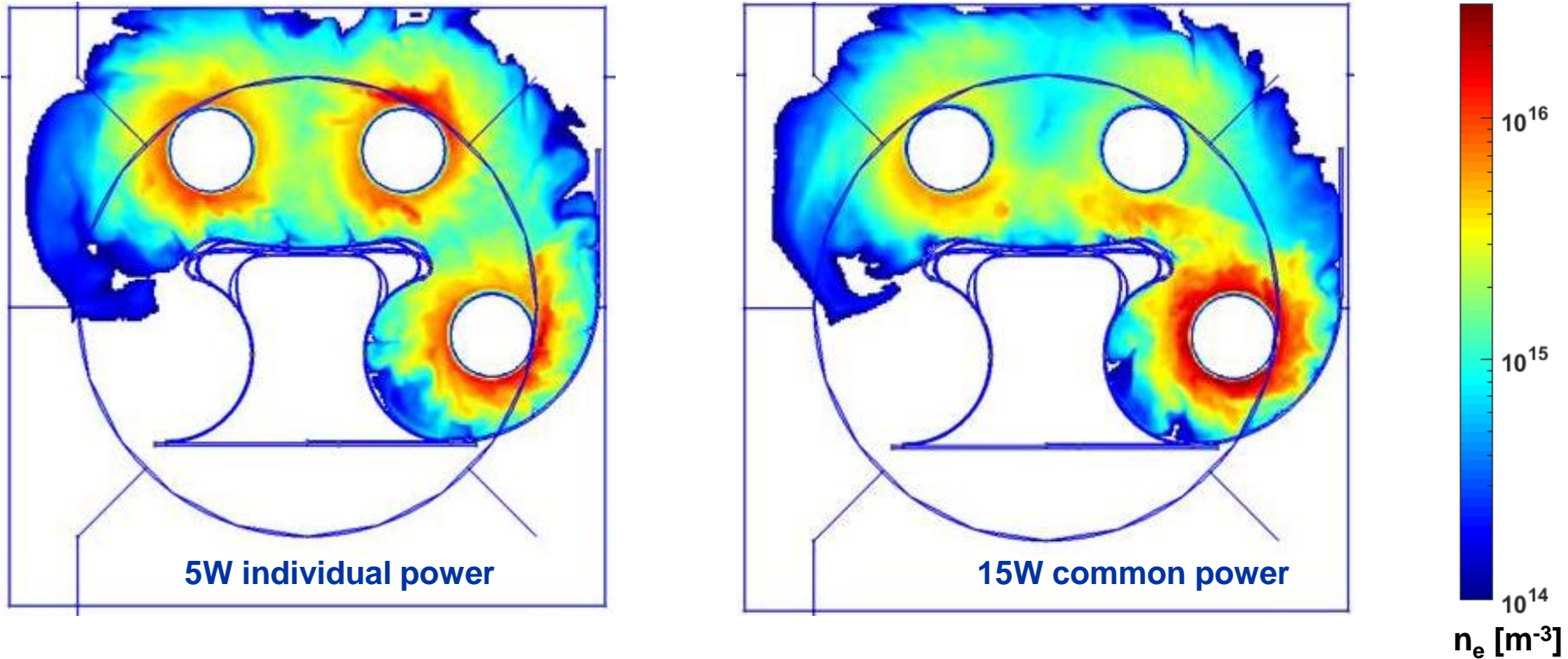
→ YET : have NO visible delamination, due to higher densities and Nb+ fractions



→ What about parallel coatings with 3 cathodes?

2 Parallel coating in DCMS

- Particle-In-Cell Monte-Carlo simulations of low power plasmas

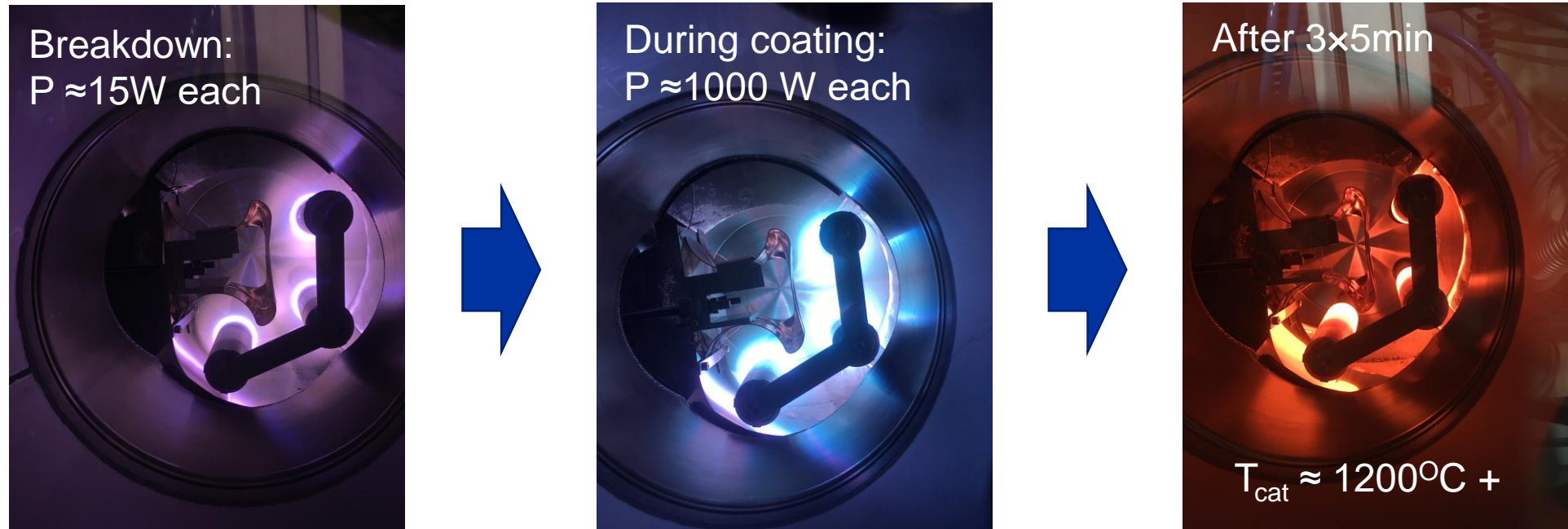


→ Confirms importance of individual powering

Preliminary result with [2],
courtesy of T. Richard

2 Parallel coating in DCMS

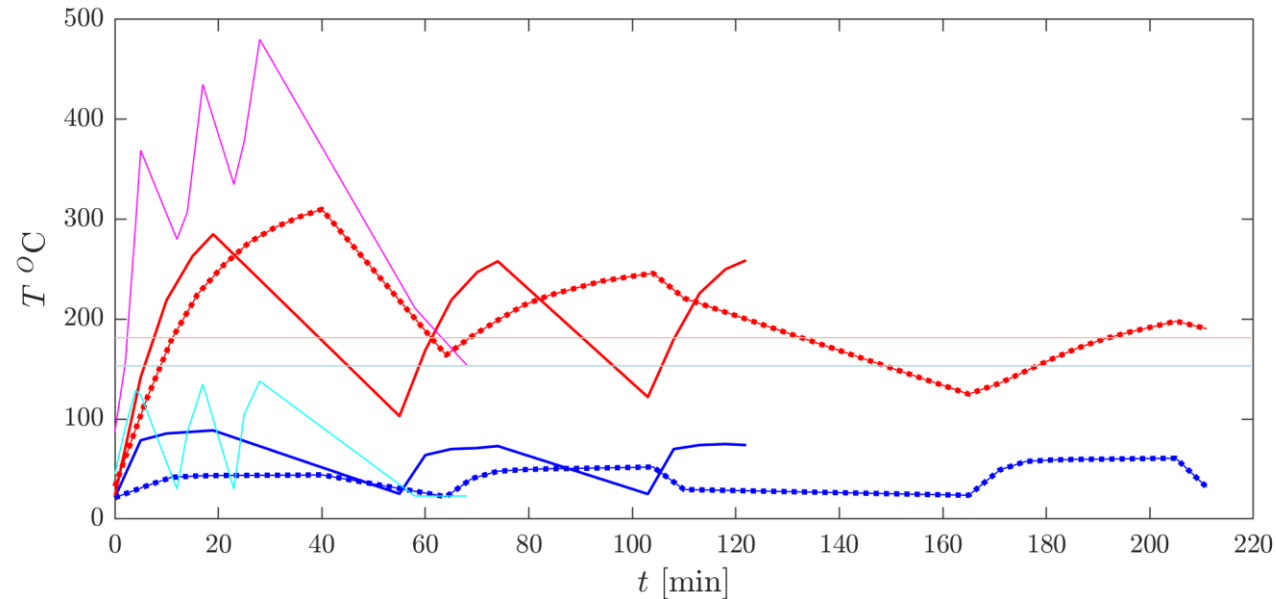
- Upgraded 3-cathode mock-up with separate bias and cooling system



→ Simulated $V_c \approx 270$ V matches experiment within 10% at 15 W

2 Parallel coating in DCMS

- Again monitor **magnet** and **sample** temperatures



→ Extreme heat-loads on samples after 2 minutes

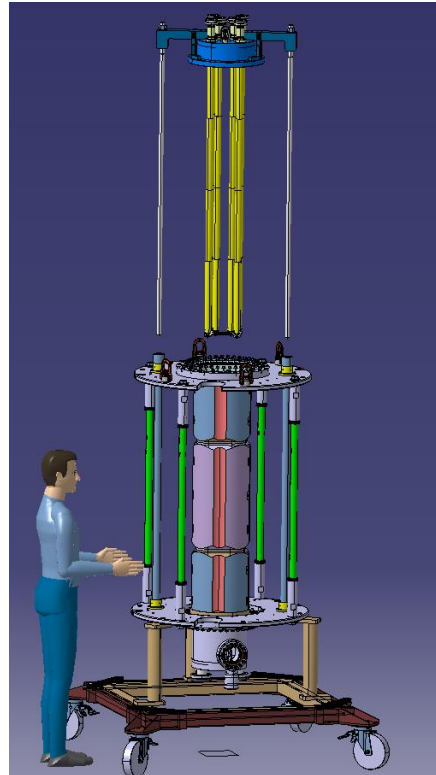
→ Upcoming: ANSYS simulation of substrate transient temperatures

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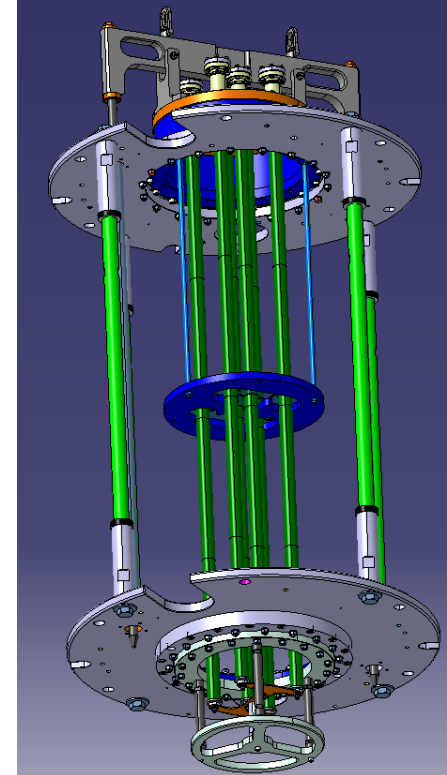
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4 Full-scale design

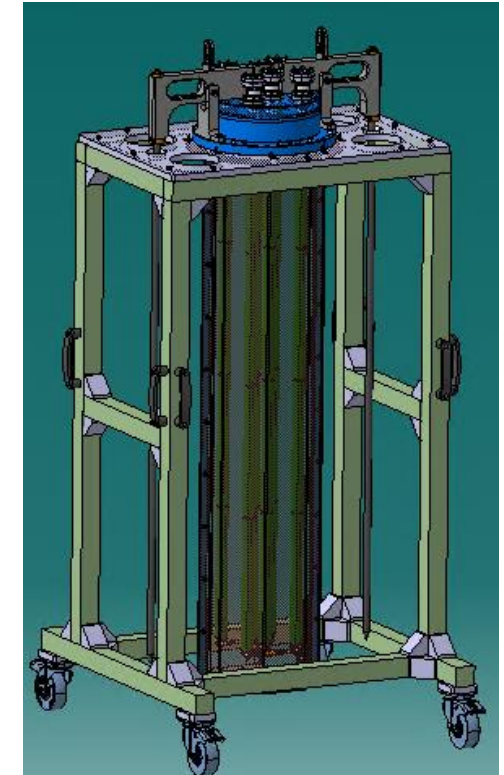
- Currently validating multiple sub-projects, moving to implementation



Cathodes during insertion (for scale)



Mock-up assembly

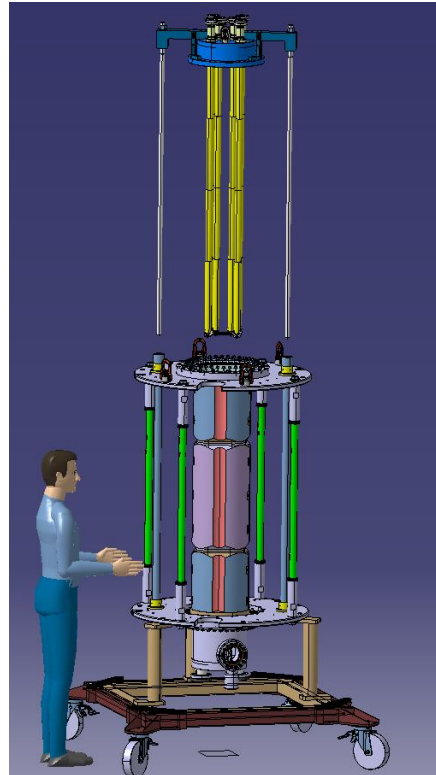


Transport and storage trolley

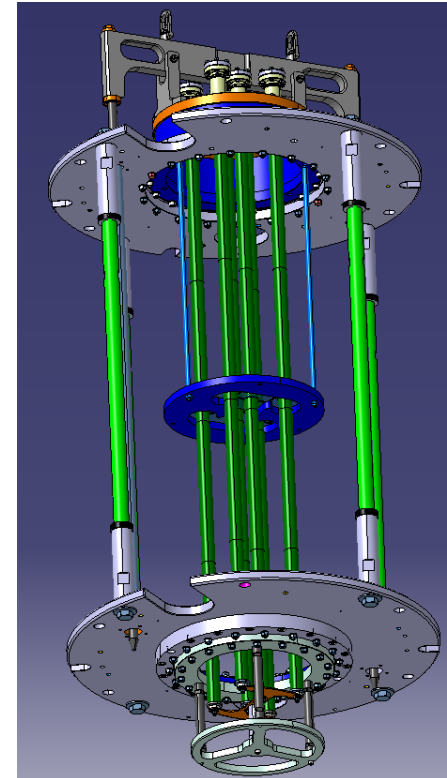
Courtesy T. Mikkola, G. Villiger

4 Full-scale design

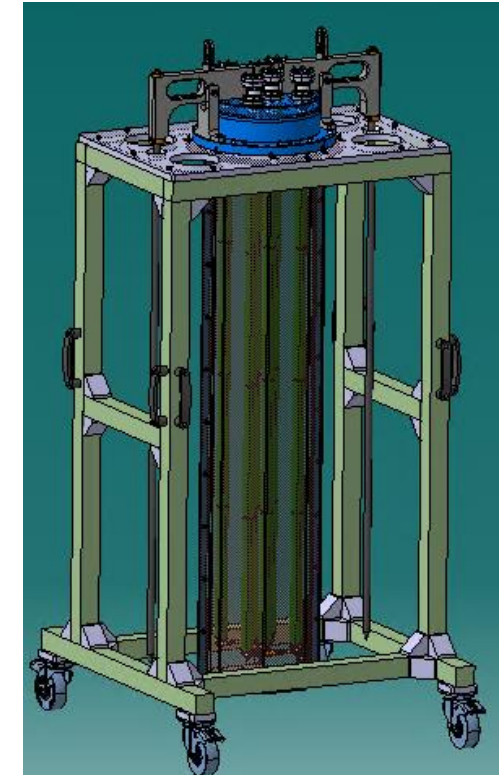
- Currently validating multiple sub-projects, moving to implementation
- Process tuning in 2021
- First coating: Q1 2022



Cathodes during insertion (for scale)



Mock-up assembly



Transport and storage trolley

Courtesy T. Mikkola, G. Villiger

Thank you for your attention !

Questions ?

Acknowledgements

- **We thank the EN-MME group for the discussion and implementation of the full-scale WOWCC coating set up design and all related drawings – in particular: P. Naisson, G. Villiger, L. Dassa, F. Cottenot and formerly T. Mikkola**
- **Further thanks go to other members of the TE-VSC-SCC section for continued input and support on experimental work – most notably: P. Garritty, G. Rosaz, S. Fiotakis, L. Mourier and W. Vollenberg**



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